

# GX76471

4x64Gbps Linear Differential I/O Driver

The GX76471 is a low-power, high-performance, quad-channel linear driver chip that is designed for 400G/600G optical integrated transmitter small form factor (SFF) modules for metro and long-haul applications. The GX76471 integrated quad lanes of driver with SPI circuitry for DC controls on a single die. Each channel of driver has  $100\Omega$  differential AC-coupled input and  $55\Omega$  differential DC-coupled output, and linear output voltage of 2.8Vppd suitable for InP and SiP multi-level modulations.

## **Applications**

- 400/600Gbps 16QAM/64QAM advanced multi-level modulation systems
- · High bandwidth SFF optical integrated modules

### **Features**

- Data rate up to 64Gbps per channel for 400G/600G DP-mQAM applications
- · > 40GHz Bandwidth
- > 10dB dynamic range of gain control
- 0.55W (typical) per channel at linear 2.8V<sub>ppd</sub>
- AC-coupled 100 $\Omega$  differential input/DC-coupled 55 $\Omega$  differential output
- · Ultra-low inter-channel cross-talk
- · Peaking adjustment functionality
- Analog control for gain and output voltage setting, and analog monitor for peak detector and gain control monitor
- OIF compliant SPI digital interface integration

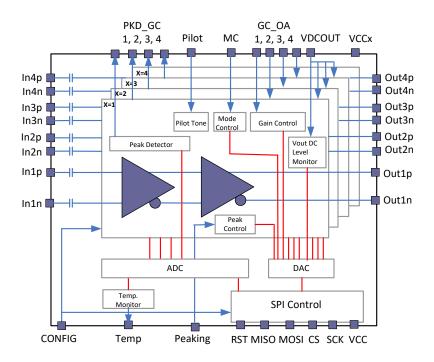


Figure 1. Block Diagram

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